MC3486 QUADRUPLE DIFFERENTIAL LINE RECEIVER WITH 3-STATE OUTPUTS

SLLS097C - JUNE 1980 - REVISED FEBRUARY 2002

Meets or Exceeds the Requirements of D, N, OR NS PACKAGE (TOP VIEW) ANSI Standards EIA/TIA-422-B and **EIA/TIA-423-B and ITU Recommendations** 1B 16 VCC V.10 and V.11 1A [15 AB 3-State, TTL-Compatible Outputs 14 🛮 4A 1Y **∏** 3 **Fast Transition Times** 1.2EN **∏** 4 13 T 4Y **Operates From Single 5-V Supply** 12 3,4EN 2Y 🛮 2A 11 3Y Designed to Be Interchangeable With 2B **∏** 7 10 3A Motorola™ MC3486 9 1 3B GND

description

The MC3486 is a monolithic quadruple differential line receiver designed to meet the specifications of ANSI Standards TIA/EIA-422-B and TIA/EIA-423-B and ITU Recommendations V.10 and V.11. The MC3486 offers four independent differential-input line receivers that have TTL-compatible outputs. The outputs utilize 3-state circuitry to provide a high-impedance state at any output when the appropriate output enable is at a low logic level.

The MC3486 is designed for optimum performance when used with the MC3487 quadruple differential line driver. It is supplied in a 16-pin package and operates from a single 5-V supply.

The MC3486 is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

	PACKAGED DEVICES						
TA	PLASTIC SMALL OUTLINE (D, NS)	PLASTIC DIP (N)					
0°C to 70°C	MC3486D MC3486NS	MC3486N					

The D package is available taped and reeled. Add the suffix R to the device type (e.g., MC3486DR). The NS package is only available taped and reeled.



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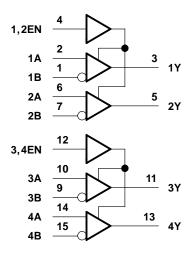


FUNCTION TABLE (each receiver)

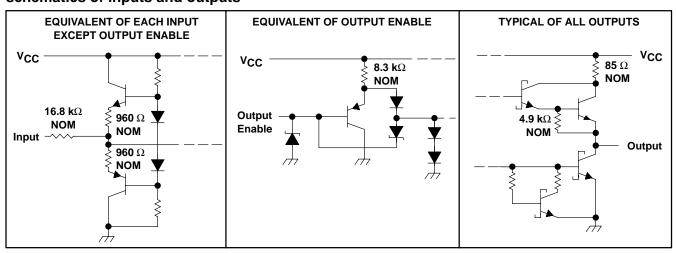
DIFFERENTIAL INPUTS A-B	ENABLE	OUTPUT Y
V _{ID} ≤ 0.2 V	Н	Н
$-0.2 \text{ V} < \text{V}_{\text{ID}} < 0.2 \text{ V}$	Н	?
$V_{ID} \le -0.2 V$	Н	L
Irrelevant	L	Z
Open	Н	?

H = high level, L = low level, Z = high impedance (off), ? = indeterminate

logic diagram (positive logic)



schematics of inputs and outputs





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	8 V
Input voltage, V _I (A or B inputs)	
Differential input voltage, V _{ID} (see Note 2)	
Enable input voltage	8 V
Low-level output current, IOL	
Package thermal impedance, θ _{JA} (see Note 3): D package	
N package	67°C/W
NS package	67°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential-input voltage, are with respect to network ground terminal.
 - 2. Differential-input voltage is measured at the noninverting input with respect to the corresponding inverting input.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.75	5	5.25	V
VIC	Common-mode input voltage			±7	V
VID	Differential input voltage			±6	V
VIH	High-level enable input voltage	2			V
VIL	Low-level enable input voltage			0.8	V
TA	Operating free-air temperature	0		70	°C

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electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
VIT+	Differential input high-threshold voltage	$V_O = 2.7 \text{ V}, \qquad I_O = -0.4 \text{ mA}$			0.2	V
V_{IT-}	Differential input low-threshold voltage	$V_{O} = 0.5 \text{ V}, \qquad I_{O} = -8 \text{ mA}$		-0.2†		V
٧ _{IK}	Enable-input clamp voltage	$I_I = -10 \text{ mA}$			-1.5	V
VOH	High-level output voltage	$V_{\mbox{\scriptsize ID}} = 0.4 \mbox{ V}, \qquad \mbox{\scriptsize I}_{\mbox{\scriptsize O}} = -0.4 \mbox{ mA},$ See Note 4 and Figure 1		2.7		٧
VOL	Low-level output voltage	$V_{\mbox{ID}} = -0.4 \mbox{ V}, \qquad I_{\mbox{O}} = 8 \mbox{ mA},$ See Note 4 and Figure 1			0.5	٧
	Lligh impodence state systems surrent	$V_{IL} = 0.8 \text{ V}, \qquad V_{ID} = -3 \text{ V}, \qquad V_{C}$	o = 2.7 V		40	
loz	High-impedance-state output current	$V_{IL} = 0.8 \text{ V}, \qquad V_{ID} = 3 \text{ V}, \qquad V_{C}$	o = 0.5 V		-40	μΑ
		VI	=-10 V		-3.25	
	Differential-input bias current	V _{CC} = 0 V or 5.25 V,	=-3 V		-1.5	mA
IВ		Other inputs at 0 V	= 3 V		1.5	
		VI	= 10 V		3.25	
1	High level enable input gurrent	V _I = 5.25 V			100	A
lιΗ	High-level enable input current	V _I = 2.7 V			20	μΑ
IIL	Low-level enable input current	V _I = -0.5 V			-100	μΑ
los	Short-circuit output current	$V_{ID} = 3 V$, $V_O = 0$, See	ee Note 5	-15	-100	mA
ICC	Supply current	V _{IL} = 0			85	mA

[†] The algebraic convention, in which the least positive (most negative) limit is designated as minimum, is used in this data sheet for threshold voltages only.

NOTES: 4. Refer to ANSI Standards TIA/EIA-422-B and TIA/EIA-423-B for exact conditions.

5. Only one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, C_L = 15 pF, T_A = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPHL	Propagation delay time, high- to low-level output	See Figure 2		28	35	ns
tPLH	Propagation delay time, low- to high-level output	See Figure 2		27	30	ns
^t PZH	Output enable time to high level			13	30	ns
tPZL	Output enable time to low level	See Figure 3		20	30	ns
tPHZ	Output disable time from high level	See Figure 3		26	35	ns
^t PLZ	Output disable time from low level			27	35	ns



PARAMETER MEASUREMENT INFORMATION

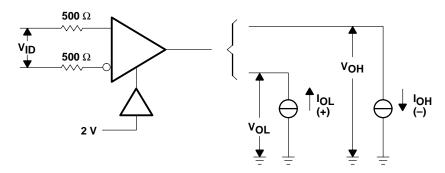
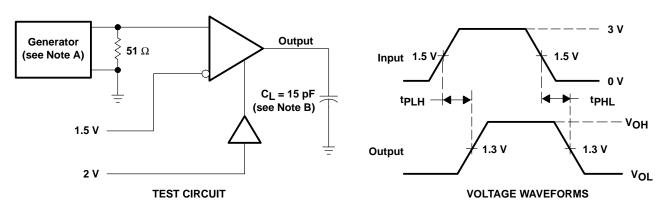


Figure 1. V_{OH}, V_{OL}

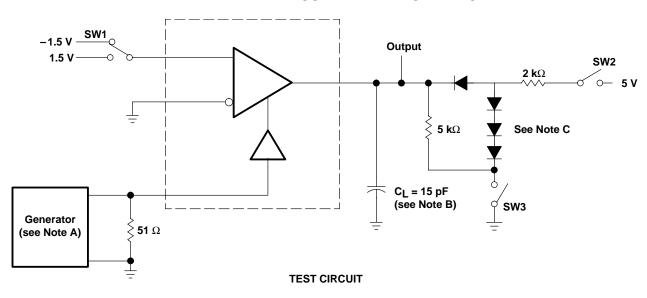


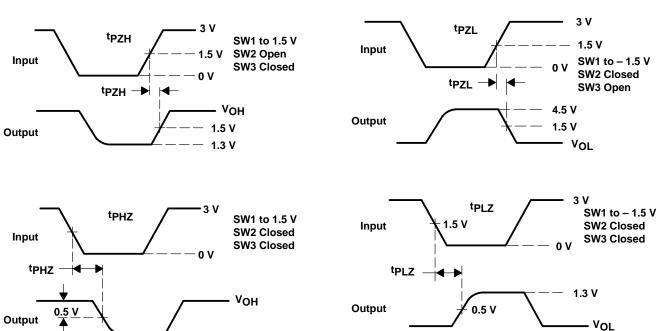
NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_{f} \leq$ 6 ns, $t_{f} \leq$ 6 ns.

B. C_L includes probe and stray capacitance.

Figure 2. Test Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION





NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle = 50%, $t_f \leq$ 6 ns, $t_f \leq$ 6 ns.

B. CL includes probe and stray capacitance.

1.3 V

C. All diodes are 1N916 or equivalent.

Figure 3. Test Circuit and Voltage Waveforms







6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
MC3486D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples
MC3486DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples
MC3486DG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples
MC3486DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples
MC3486DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples
MC3486N	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	MC3486N	Samples
MC3486NE4	ACTIVE	PDIP	N	16	25	Green (RoHS & no Sb/Br)	NIPDAU	N / A for Pkg Type	0 to 70	MC3486N	Sample
MC3486NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	MC3486	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



PACKAGE OPTION ADDENDUM

6-Feb-2020

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MC3486DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
MC3486NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
MC3486DR	SOIC	D	16	2500	333.2	345.9	28.6
MC3486NSR	SO	NS	16	2000	367.0	367.0	38.0

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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